



# Product Change Notification

## 112163 - 00

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# Product Change Notification

**Change Notification #:** 112163 - 00  
**Change Title:** Dual Port Intel® X540 10GbE I/O Module  
AXX10GBTWLIOM and  
AXX10GBTWLHW and Dual Port Intel®  
82599 10GbE I/O Module  
AXX10GBNIAIOM  
PCN 112163-00, Product Design  
Update EEPROM  
**Date of Publication:** March 29, 2013

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Apr 10, 2013
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## Description of Change to the Customer:

Intel factory has updated the EEPROM revision of the Dual Port Intel® X540 10GbE I/O Module AXX10GBTWLIOM and AXX10GBTWLHW and Dual Port Intel® 82599 10GbE I/O Module AXX10GBNIAIOM from v1.1 to v1.2.

## Customer Impact of Change and Recommended Action:

Intel recommends that customers perform a standard level of evaluation.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
AXX10GBNIAIOM	917905	G31027-003	G23589-250	G31027-004	G23589-251
AXX10GBTWLIOM	917907	G31026-004	G26218-350	G31026-005	G26218-351
AXX10GBTWLHW	924136	G72526-001	G71767-350	G72526-002	G71767-351

## PCN Revision History:

<b>Date of Revision:</b> March 29, 2013	<b>Revision Number:</b> 00	<b>Reason:</b> Originally Published PCN
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